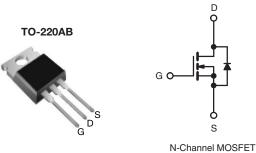


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	200			
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.40		
Q _g (Max.) (nC)	43			
Q _{gs} (nC)	7.0			
Q _{gd} (nC)	23			
Configuration	Single			



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF630PbF		
Lead (Pb)-nee	SiHF630-E3		
SnPb	IRF630		
	SiHF630		

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	200	
Gate-Source Voltage			V _{GS}	± 20	- V
Continuous Drain Current	V at 10 V	T _C = 25 °C		9.0	
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C	ID	5.7	А
Pulsed Drain Current ^a			I _{DM}	36	7
Linear Derating Factor				0.59	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	250	mJ
Repetitive Avalanche Current ^a			I _{AR}	9.0	А
Repetitive Avalanche Energy ^a			E _{AR}	7.4	mJ
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	74	W
Peak Diode Recovery dV/dt ^c			dV/dt	5.0	V/ns
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	- °C
Soldering Recommendations (Peak Temperature) for 10 s			-	300 ^d	
Mounting Torque	6.00 or 1	0.00		10	lbf ∙ in
Mounting Torque	6-32 or M3 screw			1.1	N · m

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 4.6 mH, $R_g = 25 \Omega$, $I_{AS} = 9.0$ A (see fig. 12).

c. $I_{SD} \le 9.0$ A, dI/dt ≤ 120 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.7	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μΑ	200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = 1 mA	-	0.24	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20 V$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	-	$= 200 \text{ V}, \text{ V}_{\text{GS}} = 0 \text{ V}$	-	-	25	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{DS} = 160 V_{GS} = 10 V$	$V, V_{GS} = 0 V, T_J = 125 \text{ °C}$ $I_D = 5.4 \text{ A}^{\text{b}}$	-	-	250 0.40	Ω
Forward Transconductance	gfs		$= 50 \text{ V}, \text{ I}_{\text{D}} = 5.4 \text{ A}$	3.8	-		S
Dynamic	9ts	VDS	= 30 V, I) = 3.4 A	0.0			0
Input Capacitance	C _{iss}			-	800	-	
Output Capacitance	Coss		$V_{GS} = 0 V,$ $V_{DS} = 25 V,$	-	240	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	76	-	
Total Gate Charge	Qg			-	-	43	1
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 5.9 \text{ A}, V_{DS} = 160 \text{ V},$ see fig. 6 and 13 ^b	-	-	7.0	nC
Gate-Drain Charge	Q _{gd}		see lig. 6 and 15	-	-	23	
Turn-On Delay Time	t _{d(on)}	V_{DD} = 100 V, I_D = 5.9 A, R_g = 12 $\Omega,~R_D$ = 16 $\Omega,~\text{see}$ fig. 10^b		-	9.4	-	- ns
Rise Time	t _r			-	28	-	
Turn-Off Delay Time	t _{d(off)}			-	39	-	
Fall Time	t _f			-	20	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal Source Inductance	L _S			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						•
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	9.0	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	36	
Body Diode Voltage	V_{SD}	$T_J = 25 \ ^{\circ}C, \ I_S = 9.0 \ A, \ V_{GS} = 0 \ V^b$		-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	T _ 05 °C			170	340	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = 5.9 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}$		-	1.1	2.2	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)			L _D)		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

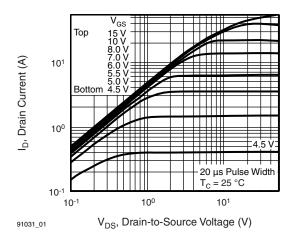


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

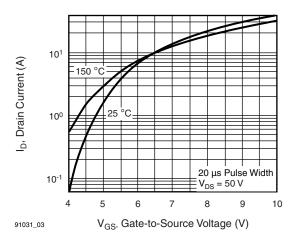


Fig. 3 - Typical Transfer Characteristics

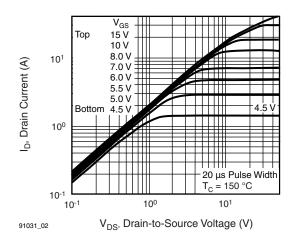


Fig. 2 -Typical Output Characteristics, $T_C = 150 \ ^\circ C$

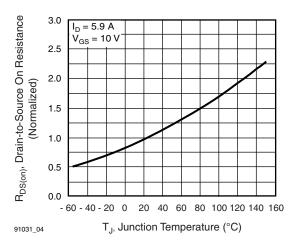


Fig. 4 - Normalized On-Resistance vs. Temperature

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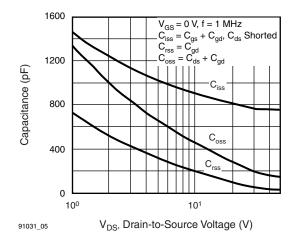


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

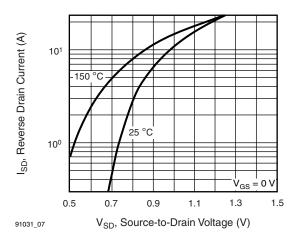


Fig. 7 - Typical Source-Drain Diode Forward Voltage

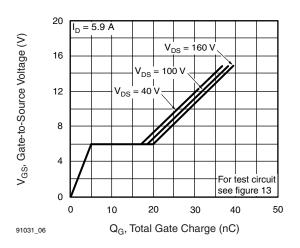


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

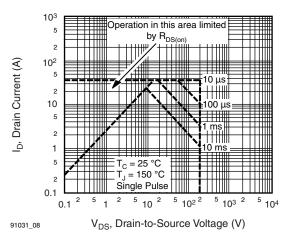


Fig. 8 - Maximum Safe Operating Area

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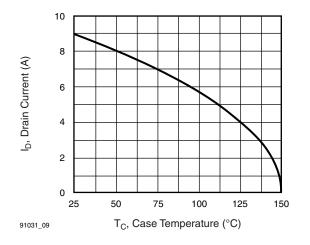


Fig. 9 - Maximum Drain Current vs. Case Temperature

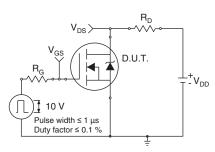


Fig. 10a - Switching Time Test Circuit

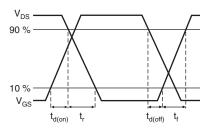


Fig. 10b - Switching Time Waveforms

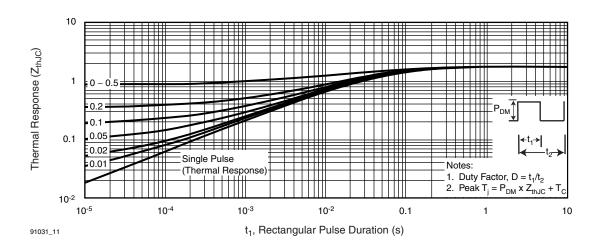
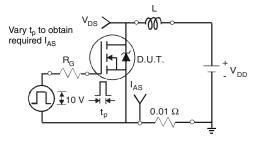
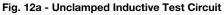


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





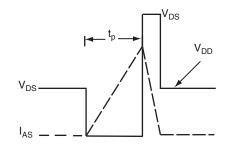
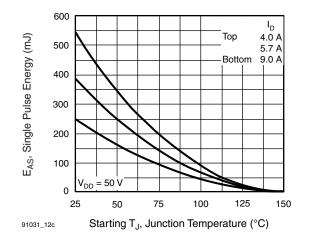


Fig. 12b - Unclamped Inductive Waveforms

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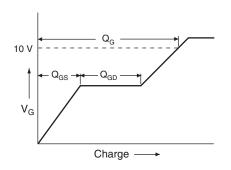


Fig. 13a - Basic Gate Charge Waveform

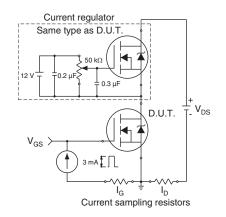
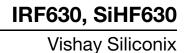


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

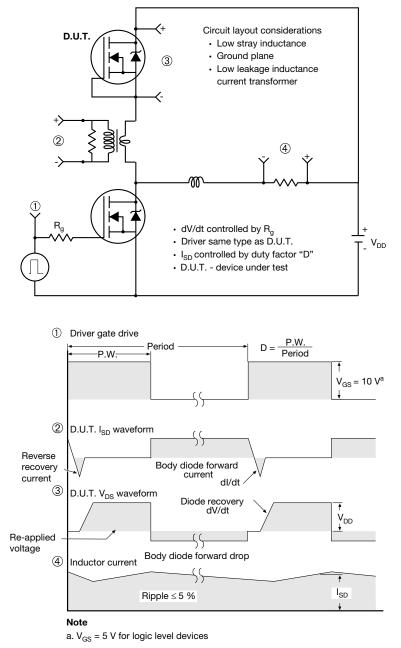


Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	MILLIMETERS		INCHES	
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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